Release 2023 R1 Highlights Ansys Twin Builder



What is a Digital Twin?

Past, Present, Future, Simulate!

digital twin: "Virtual representation of real-world entities and processes, synchronized at a specified frequency and fidelity"

Customer Value: Track the past, provide deeper insights into the present, predict and influence future behavior



Sources:

1. "Industrial aftermarket services: Growing the core.", McKinsey.com

2. "Controlling Warranty Costs by Preventing No Fault Found", WIKA Group

3.. Total addressable market (TAM) and compound annual growth rate (CAGR) information throughout presentation is based on third party study completed by Evaluserve Inc. in 2019 commissioned by ANSYS. Study was based on customer and industry expert interviews and review of industry analyst reports and commentaries. Refer to Cautionary Statement for a discussion of factors that could impact future financial results.

Ansys Leading the Way in Global Digital Twin Initiatives

Digital Twin Consortium

GE Digital

• Ansys is one of 8 founding members

AUTODESK. Bentley



• Drives the development and adoption of digital twin technologies

Microsoft

• Emerging standards body (part of OMG)

Digital Twin Definition Language (DTDL)

- Ansys and Microsoft collaborating on DTDL and on developing reusable reference architecture
- Enabling IoT solutions to provision, use, and configure IoT devices from multiple sources in a single solution

Accurate & Evolving Digital Twins with Twin Builder Hybrid Analytics



Increase Digital Twin Prediction Accuracy with Hybrid Analytics

- Model Exchange FMU support with new solver in Twin Deployer improves interoperability and simulation stability
- Improved documentation and API examples make it easier to get started with deployment
- Automate Runtimes deployment in Python with **PyTwin**

Automation, Speed & Accuracy for ROM creation

- New Linear Static and Dynamic ROMs offer faster and more accurate ROMs for a variety of applications
- ✓ Improved ROM visualization with the ability to generate ROM images with geometry deformation
- Automate your ROM creation with PyAEDT, which now includes new examples for creating static and dynamic ROMs

Enhanced Solver and Model Library and User Experience

- ✓ Improvements to Modelica Editor Bijection (Text-to-Diagram) support, which allows users to switch between text and diagram views for easier model creation
- Easier workflow with "Wire Together", which allows for easier pin connection for components with large numbers of pins
- Create and Export videos from your ROM images for better visualization



Innovations in Ansys Digital Twin 2023 R1

Transform Your Operations with Data-Driven and Simulation-Based Digital Twin Software

Export and Scaled Deployment

- Support for Hierarchical Parameters in the Model Parameter Dialog
- Model Exchange (ME) FMU Support in Twin Deployer
- Examples of Simpler Scaffolding Code for Easier API Understanding
- Improved ROM Image Generation Support in the Deployment Package
- New Improved API Documentation
- Several Enhancements and Bug-Fixes
- Automate Runtimes deployment in Python with PyTwin

Reduced Order Model

- New Linear Static ROM with Support for Large Number of Parameters
- New Linear Dynamic ROM
- Cut-plane coordinate Specification by Orientation and Origin
- Improved Workflow for Renaming Input/Output Pins for ROMs
- Image Generation with Geometry Deformation
- Improvements on modal ROM export from Mechanical

Model Building-Modelica Enhancements

- Modelica Editor Bijection (Text-to-Diagram) support
- Modelica Enhanced Diagram Graphics
- Support for Hierarchical Display and Editing of Parameters

Solver and Model Library

- Usability Improvements for Device Characterization Wizard
- Support for Gradient Fitting in Device Characterization
- New Basic Dynamics MOSFET Model with Q3 control (Beta)
- Carrier Wave Options in the SVPWM Component

General Enhancements

- Easier Pin Connection for Large Components
- Twin Builder ROM Animation Video Export
- Example of ROM creation using PyAnsys
- Easy Debug and Error Log Access



Hybrid Digital Twin



Challenges in Creating a Digital Twin





'<mark>\nsys</mark>

Digital Twin Goals: Accuracy, Time, and Cost

Customers are demanding more from their products, pressuring manufacturers to produce faster, better, and more reliable designs

Data and simulation approaches each make reasonable predictions, but also both face limitations



The Solution: Hybrid Digital Twins, the Best of Machine Learning and Physics

Hybrid Analytics is a toolset for combining data and physics modeling using machine learning techniques to create Hybrid Digital Twins





How Does it Work?

Combine data and physics to create the best possible digital twins





Hybrid Analytics Techniques



//nsys

Hybrid Analytics Capabilities

Transform your operations with data-driven and simulation-based digital twin software











Unparalleled Accuracy

Closely match simulation results with measurement data by calibrating model parameters Uncertainty Quantification

Uncertainty quantification on parameters and outputs provides confidence in fit Fusion Modeling

Compensate for any unmodeled physics or other effects by modeling the difference between a physics model and data Robust Algorithms

Cover diverse use cases Easy Online Recalibration

Quickly recalibrate digital twin with online recalibration



Hybrid Digital Twin: Combine ML-Based Analytics with Physics-Based Approaches to Create Accurate and Evolving Digital Twins

Using hybrid analytics techniques, the resulting hybrid digital twin is more accurate than if using either just data and machine learning of physics simulation alone.



Hybrid Digital Twin Key Benefits

Create virtual sensors to measure missing data





Perform what-ifs before applying a solution

Analyze accurate and deterministic predictions based on physical principles





Explore causality and failure modes using physics



Export and Scaled Deployment

Easily Export and Deploy Digital Twins



Model Exchange (ME) FMU Support in Twin Deployer

What's New

• Support for FMI 2.0 Model Exchange FMUs



- ME simulation stability has been improved.
- For improved simulation stability, the FMU Sundials CVODE solver is used to perform numerical integration.





Extend API and Automation through PyAnsys/PyTwin

What's New

- Expose deployment workflows to PyAnsys/PyTwin
- Provide new Python workflows for Runtime integration with examples of new use cases (twin consumption, offline twin application, ROM results and connection with Ansys flagships,...)

- PyTwin makes it simple to test and automate Twins deployment in Python.
- The SDK API's high-level abstraction makes it even easier to interact with Twin to Initialize/Simulate/Post process the Twins.
- Leverage new workflow opportunities when connecting with Python ecosystem (including other PyAnsys packages)





Easier Scaffolding Code Examples for Getting Started (1/2)

What's New

• Example of auto-generated clients moved to separate folders in Twin Deployer

User Benefits

1_hello_world

- Only basic error handling to keep simplicity
- Easier to understand the API usage
- 2_generated_clients
 - Hides implementation details regarding API endpoints and payloads
 - Common API errors handled by generated clients
 - Focus on application usage rather than on the REST API behavior





Easier Scaffolding Code Examples for Getting Started (2/2)

What's New

- Updates on sample clients
 - A new hello_world.py example for simple and advanced.py for more advanced APIs
 - By default, hello_world.py is executed when executing the run_windows.bat/run_linux.sh scripts
 - Updated some embedded dependencies to ensure compatibility with both Ubuntu20.04 and CentOS7.8/7.9

- 'hello world.py' example contains much simpler sample client code that only runs a Batch Mode CSV simulation (fastest simulation mode)
- Easier for new user to get started with the API

aff/amaron/Documents/pyapp/TwinDemoProject	× ×
Name	▼ Size
initpy	0 bytes
advanced.py	17.0 kB
hello_world.py	7.1 kB
input.csv	2.7 kB
model.twin	1.9 MB
o model_setup.json	189 bytes
reference_output.csv	5.4 kB



New Improved API Documentation for Deployment

What's New

 New Improved API documentation is exported from Twin Deployer

User Benefits

 The new improved style and exported sample code make the documentation more accessible to understand the different APIs and their payloads.

Simulation API TO CONSTITUTION OF CONSTITUCIÓN OF CONSTINON OF CONSTITUCIÓN OF CONSTITUCIÓN OF CONSTITUCIÓN OF	TD	
Servers (host}/simulation/v1.11.2 - Default base path ~ Computed URL/simulation/v1.11.2 Server variables host	Authorize 🔒]
License	>	
Data [CSV]	>	
Simulations	~	
GET /interpreter/python Retrieve default python version, path and all installed python packages	â	
GET /simulations/ List current simulations		



Support for ROM Image Generation in Deployment Package

What's New

 New API endpoints for ROM .modbin/.png file generation and retrieval



- Currently, ROM models require X server and display access from within the container, making .png file generation impossible in headless environments (i.e., cloud). This capability enables it.
- Files are downloaded as .zip file



API Versioning Support in Endpoint URLs

What's New

 API endpoint URLs have been updated to support multiple versioning options, making it easier to maintain legacy client code.

> localhost:9080/simulation/v1.10.2/simulations localhost:9080/simulation/v1.10/simulations localhost:9080/simulation/v1/simulations

User Benefits

 Customers can deploy containers from multiple Twin Deployer versions without changing their client applications, unless the major versions changes (i.e., a breaking change was introduced)



Twin Deployer: Model Parameter Dialog Enhancements

What's New

 New Model Parameter Dialog enhancement in Twin Deployer

Search				
Name		Start	Туре	Unit
solver	1	11	1	
method	1.4	TWIN_V	ARPROP_NOTDEFIN TWI	N_VARPROP_NOTAPPLI
method	1	11	ED	CABLE
abstol	1e-12 🖍	TWIN_V	ARPROP_NOTDEFIN TWIN	VARPROP_NOTDEFIN
805101	//	11	ED	ED
reltol	0.0001 🖌	TWIN_V	ARPROP_NOTDEFIN TWIN	VARPROP_NOTDEFIN
Teltor	//	11	ED	ED //

- Model parameter grouping (Twin, FMU) based on name¹
- The folding and unfolding of the parameter tree structure
- Possibility of searching the parameters
- Column selection capability



Other Enhancements

What's New

- Updated Twin Deployer documentation in the installation
- Other Usability enhancements

- Improved usability and stability
- The new improved style makes the documentation easier to access and consume.

Generation Settings	
Twin inputs (.csv)	tdr://project_hnnwuXd/TwinInputs.csv
Twin outputs (.csv)	tdr://project_hnnwuXd/TwinOutput.csv
Target behavior (.csv)	tdr://project_hnnwuXd/TargetBehavior.csv
Training ratio (?	0.8
Export folder	file://D:\test-resource\twin-deployer\fusio
GEN [08/22/2022 11:26:24 AM] INF(Fusion model creation started	COPEN FOLDES
GEN [08/22/2022 11:26:24 AM] INF(
(08/22/2022 11:26:24 AM] INF(Fusion model creation starter [08/22/2022 11:26:24 AM] INF(Configuration successfully cl	ERATE OPEN FOLDER 0:
CEN [08/22/2022 11:26:24 AM] INFT Fusion model creation starter [08/22/2022 11:26:24 AM] INFT Configuration successfully cl 	TRATE > OPEN FOLDER





Reduced Order Model

Enhancements to Reduced Order Model and Workflows



New Linear Static ROM that handles a large number of parameter

What's New

 New Linear Static ROM that handles a large number of parameter

- Ideal for Electronics/Thermal applications, but also applicable to other problems.
- To characterize an n-parameter problem, a linear problem requires only n+1 snapshots.



New Linear Dynamic ROM (Linear TDVF)

What's New

• New Linear Dynamic ROM Linear TDVF (Linear Time Domain Vector Fitting)



- Linear TDVF is a very effective linear dynamic ROM algorithm making simulation much faster
- The trapezoidal rule is used for convolution making it very robust
- Field inputs are also supported.





Cut-plane coordinate Specification by Orientation and Origin

What's New

- Improved Cut-plane Coordinate Specification by Orientation and Origin
- Generate a cut-plane by click (with mouse)
- Ability to edit its orientation and origin using UI

User Benefits

• Easier and better control of cut-plane coordinate specification with mouse and UI





Improved Workflow for Renaming Input/Output Pins for ROMs

What's New

 Improved Workflow for renaming Input/Output Pins for ROMs

- The ability to rename each pin (input and output) at exporttime.
- At export-time, you can specify whether a ROM input parameter will be considered as an input or parameter (e.g., for hybrid calibration) for the exported model.





Image Generation with Geometry Deformation

What's New

• Image Generation with Geometry Deformation

User Benefits

• Geometry deformation support for image generation allows users to generate images from ROM and Twins.



Improvements on SPM ROM/Modal ROM Export from Mechanical

What's New

- SPM ROM/Modal Field ROM for Mechanical to Twin Builder Improvements
 - Include highest frequency value in the FMU export to suggest Max timestep in Twin Builder
 - Include solver type in the FMU/TBROM export (Model Exchange or Cosimulation)

User Benefits

- Better usability and less error prone
- Improved stability

	0.11_1011_2A0.02001	
<u>⊨</u>	Solution (A6)	
	FMU file	Import ROM Model
Commentary Scoping Method Geometry Definition Method NMODES Damping NIC VelAcKey FileFormat Score EMIL Model FMU Type ROM path	Geometry Selection 1 Body Modal All Modes No No No Off Twin Builder SML Vec Co-simulation Model Exchange Co-simulation	FMI Version : 2.0 ROM Type: : DynamicROM Interface Selection □ Display Attributes Select Local Variables Select Interfaces at Level [1 (A)] ▼ Image: Select Display Attributes Select Interfaces at Level [1 (A)] ▼ Image: Select Display Attributes Select Interfaces at Level [1 (A)] ▼ Image: Select Display Attributes Select Interfaces at Level [1 (A)] ▼ Image: Select Display Attributes Select Display Attributes Image: Select Display A
Details of "Gen	Solution (B6) Solution Information Generational Deformation 2 Directional Deformation Total Deformation Total Deformation Comparison Directional Deformation Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Comparison Compariso	eters
Definition Model path	D:\TEMP\09_modal_field_202	3R1\Mech_LND_2020R1_\
Type Default Outp Min NORM Max NORM Mode coeffici Manual Outp	Co-simulation ut pin Model Exchange Co-simulation res ints ints ints ints ints	- 1.4 12° Crade -1.4 12° anting backton dearing -1.4 12° anting backton
activate	No	Import Cancel

SPM ROM extension



Model Building – Modelica

Enhancements to the Modelica workflow



Modelica: Enhanced Diagram Graphics

What's New

- Modern and Enhanced Graphics in Modelica Editor
 - Support for Gradient fill in component icons
 - Support for Anti-Aliasing and transparency in images
 - Support for different pattern styles and line styles
 - Improved drawing for text in icons

- Better graphics support conforms the graphics to the Modelica standard.
- It is now possible to import libraries with advanced graphics features.





Improved Bijection in Modelica Text Editor

What's New

- Add new parameters or modify existing outputs in Text Editor
- Support for component parameter modification in Text Editor
- Support for "Extend" model from library in Text Editor

- The capability allows you to make direct design changes in either text or diagram view and have them reflected in the alternate view.
- Make Modelica model creation faster and preserver changes across both views.





Modelica: Hierarchical Display and Editing of Parameters

What's New

- Hierarchical Display of Parameters
 - Internal parameters can be exposed in Modelica and other FMUs using the dot notation
 - Component dialog now supports ability to show selected internal parameters as a multi level tree control

User Benefits

Improves usability and readability



npingSystem L	Inits leter g_per_s	Construction C
ls m k k k	Inits ieter g_per_s	Construction C
15 m	Jnits ieter g_per_s	Description Number of identical parallel pipes Average height of surface asperties (idefault: s (Inht rev/min) Nominal rotational speed for flow
l5 m k	lnits leter g_per_s	Description Number of identical parallel pipes Average height of surface asperties (default: s (Unit rev/min) Nominal rotational speed for flow
15 m k k	neter g_per_s	Number of identical parallel pipes Average height of surface asperties (default: s (Unit.rev./min) Nominal rotational speed for flow
l5 m k	neter g_per_s	Number of identical parallel pipes Average height of surface asperities (default: s (Unit:rev/min) Nominal rotational speed for flow
15 m	neter g_per_s	Number of identical parallel pipes Average height of surface asperities (default: s (Unit:rev/min) Nominal rotational speed for flow
15 m k	g_per_s	Average height of surface asperities (default: s (Unit:rev/min) Nominal rotational speed for flow
k	g_per_s	(Unit:rev/min) Nominal rotational speed for flow
k k	g_per_s	(Unit:rev/min) Nominal rotational speed for flow
k	g_per_s	
k		Nominal mass flow rate, fixed if control_m_flow
	g_per_s	Guess value of m_flow = port_a.m_flow
		= true if cross sectional area is circular
		Number of identical parallel pipes
5 k	el	Start value of temperature
m	ieter	Height of tank
m	ieter	Start value of tank level
		Bandwidth around reference signal
		Value of pre(y) at initial time
		= true if cross sectional area is circular
m	neter	Length
		Number of identical parallel pipes
		(Unit rev/min) Nominal rotational speed for flow
m	13_per_s	Used for simplified initialization model
		Number of pumps in parallel
0 р	ascal	Guess value for outlet pressure
0581525969		(Unit:J/kg) Boundary specific enthalpy
0581525969		(Unit:J/kg) Boundary specific enthalpy
	5 k m m m m 0 p	5 kel meter meter meter m3_per_s 10 pascal



Solver and Model Library

Enhancements in Solver and Model Library



Usability Improvements for Device Characterization Wizard

What's New

- Simplified Thermal Fitting Page
- New selection of Fitting Type
- Simplified Selection of Channel Type

No Data Available or I	Isothermal		🎉 5SNA0800N330100 [Basic Dynamic IGBT] - IGBT Thermal Mo	del [8/12]
Use Transient Ther Characteristic Data Transient There test	mal Impedance C Use Fraction Co	efficients Heatsink Use external network Rthck Te-06 Cthck T00000	No Data Available or isothemal C Use Translert Themal Impedance C Use Fraction Cod Characteritic Data D Data	fficients Heatsink I Use external Rthck 1e-06 Othck 10000
0.0000000000000000000000000000000000000	00007420100020 V		0.001208795 0.0007808398753833 🔽 0.001461187 0.0099043080791226 🔽 0.001650619 0.0009972851734153 🖵	Thermal Network T Partial Fraction
No Data Available or C Use Transient The	Isothermal email impedance 🌾 Use Fraction (Coefficients	0.005510305.001427/031222/04 V 0.00551035.00137520150156421 V 0.013111339.00297464850452942 V 0.039810717000469206620596215 V	Model Thermal O
- Thermal Coefficients -		Heatsink	0.125892541 0.00791525974629819	
i 🗟 📑 >>		🗖 Use	0.299550872 0.0105300907335256	
R(i) [K/W	(] Tau(i) [s]	Rthck	Contra -	
0.000268685	0.48584427755	Cthck	Fitting Type : RMS Etting	Sho
0.00681307	0.236761676877		Chang type . [King hang	
0.00396287	0.052032086813	- Themal N		
0.00165808	0.0024462814896	Partial F	Import Model Save Model	

User Benefits

- Better usability
- Gradient fitting is a new option that work better in some cases
- More intuitive selection for choosing the channel type



Component Name	component	
Material	Silicon	•
Channel	N-Channel	•



mal Canacitance IWs/K

Result Show Log Start Fitting

Next > Cancel

Support for Gradient Fitting in Device Characterization

What's New

• Support for Gradient Fitting in Device Characterization

- In some cases, it is advantageous to use Gradient Fitting instead of RMS Fit:
 - Results are not satisfying, or fitting takes too much time.
 - Some model parameters run out of the expected scope.
 - Simulation using the final component shows convergence issues.
 - Find the best compromise of a general unsatisfactory fitting result.

🔀 5SNA0800N	330100 [Basic [)ynamic IGBT] - Tra	ansfer Cl	narao	acteristic lc = f(Vg	je) [5/12]		×
Ch.01 - 125.0)°C <u>Ch.02 - 25</u>	0°C			Boundan	Conditions		₩ 🖾 🗙
1		## 🖾 🗙	⊁ ≁	÷	Temp	125 -	Temperature [°C]	
	Vge [V]	Ic [A]	Enable	^	Vce	20	Const. Collector-Emitter Vol	tage [V]
7.180	77474892396	27.96504369538	~	1	- Etting Ba			
7.311	33428981348	29.96254681647	~		lo min	27.96	Minimum Current [A]	
7.441	89383070301	37.95255930087	~			27.50		
7.553	80200860832	47.940074906367	~		lc max	1598.01	Maximum Current [A]	
7.684	36154949785	59.92509363295	~					
7.870	87517934003	75.90511860174	~					
8.001	43472022955	93.88264669163	~					
8.187	794835007174	119.8501872659	~		- Fitting Ch	aracteristic Orde	er	
8.393	311334289813	155.8052434456	~		Ch 01 -	125.0°C	Nominal Temperature	
8.542	232424677188	189.76279650437	~		Ch. 02	DE 0%C		
	F0545064560	220 7120500202		*	JCn.02 - /	25.0 C		*
Fitting Fitting Typ	De : RMS Fittin RMS Fittin Gradient F	ng 👻			Validate	Show Result	Show Log Start Fi	tting
Import Model	<u>S</u> av	e Model					< <u>B</u> ack <u>N</u> ext >	Cancel



New Carrier Wave Options in the SVPWM Component

What's New

• New Carrier Wave Options in the SVPWM Component



Paramet	ers - svpwm1 - Sp	bace vector PWM signal generator for 2 level three phase converter (VHDL-AMS).		×
Properti	es Output / Display	y]		
Name	svpwm1		Show	
Prop	erties			_
Sim	nulator Model	Simplorer Elements\Power System VHDLAMS\Power System VHDLAMS:svpwm - mid_align	•	
		Simplorer Elements\Power System VHDLAMS\Power System VHDLAMS:svpwm - mid_align		
	Name	Simplorer Elements\Power System VHDLAMS\Power System VHDLAMS:svpwm - right_align	1	
	freq	Simplorer Elements\Power System VHDLAMS\Power System VHDLAMS:svpwm - left_align		
	dead_time	1e-07		

- This new option of carrier wave allows for all three options:
 - mid_align triangle source for carrier wave.
 - right_align right sawtooth source for carrier wave.
 - left_align left sawtooth source for carrier wave.





Enhancements for MATLAB Workflows

What's New

- Simulink Co-simulation update in Twin Builder
 - Added support for MATLAB versions R2021b and R2022a.
 - Removed older versions R2017b and R2018a.
- LTI toolkit export for MATLAB now contains information for input and output name and reference values

- Additional information has been added to the m-file to better support MATLAB users.
- Easier reuse of LTI-ROMs in MATLAB/Simulink

1	% Input_vec = [
2	% input_1
3	% input_2
4	% Ref_output1 = refVal
5	% Ref_output2 = refVal
6	%]
7	
8	% Output_vec = [
9	% output1
10	% output2
11	%]



New Basic Dynamics MOSFET Model with Q3 control (Beta)

What's New

- New Basic Dynamics MOSFET Model with Q3 control (Beta)
- Q3 model can only be generated by Characterization Wizard through a special workflow
- Regular wizard workflow still generate the old MOSFET model with no reverse conduction

User Benefits

 Regular MOSFET models in TB cannot conduct reverse current through transistor and a new basic dynamic model MOSFET_Q3 is added to solve this limit



- How to recognize MOSFET Q3 model
 - "Q3" mark on symbol
 - "(w. Q3C)" on component parameter page
 - Extended list of static parameters in tab "Drain-Source Diode"



General UI/UX Enhancements



Wire Together: Easier Pin Connection for Large Components

What's New

- Wire Together Two Large Components with the help of UI
- Supports pins with direction (in, out)
- Allows Filtering on large pin list
- Works also with rectangular symbols
- Multi select to connect many pins

User Benefits

• Improved usability for connecting components, particularly those with large number of input and output pins





Twin Builder ROM Animation Video Export

What's New

- Export ROM Field Snapshot Animation as a movie
- New Script Command ExportAsMovie() is also available

	STATIC ROM COMPONENT
Export Field Snapshot Movie × Inputs and Outputs Input Folder: D:/AnsysEM/v231/Win64/Examples/Twin Builder/Applications/ROM View: View1 Output File: D::\AnsysEM/v231\Win64/Examples\Twin Builder'Applications/ROM Animation\? Settings Settings	
Image Frames Found: 60 Start Time: 5.100000 Frame Rate: 20 Frames/Second Resolution: 640 X [S12] V Launch Movie	Exported Movie File
OK Cancel	0.706 0.647 0.459 0.471 0.472 0.353 0.254 0.254 0.776 0.472 0.353 0.254 0.776 0.776 0.472 0.353 0.254 0.776 0.677 0.472 0.559 0.472 0.472 0.559 0.472 0.472 0.559 0.472 0.472 0.559 0.472 0.559 0.472 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559 0.559



• Easily create and share ROM animation from Twin Builder



Automation with pyAnsys/pyAEDT: ROM creation using python

What's New

• New example for creating Static ROM and Dynamic ROM

- Scripting examples on GitHub/pyAnsys can run on command line or in a Jupyter Notebook
- Automate workflows for easier ROM creation

) 🧧 03-Dyna	amic_ROM_Creation_And, × +	- • ×	
$\leftarrow \rightarrow$ C	localhost:8888/notebooks/03-Dy	nami A 🗔 🤉 🏠 🗲 🔂 🙎 …	
or quick access, place your favorites here on the favorites bar. Manage favorites now			
ブ JUPyter 03-Dynamic_ROM_Creation_And_Visual Last Checkpoint: 29 minutes ago (unsaved changes) 🥐 Logout			
File Edit View Insert Cell Kernel Help Not Trusted Python 3 (ipykernel) O			
_			
	Twin Builder: dynamic ROM creation and simulation (2023 R1	beta)	
	This example shows how you can use PyAEDT to create a dynamic ROM in Twin Builder		
	and run a Twin Builder time-domain simulation. note::	C - C - X - C - X	
	For 2023 R1, the build date must be 8/7/2022 or later.	\leftarrow \rightarrow \mathbb{C} $\widehat{\square}$ \bigcirc localhost:8888/notebooks/04-Static_R A ^h \square \bigcirc \bigcirc \bigcirc \clubsuit \textcircled{f}	
	*****	For quick access, place your favorites here on the favorites bar. <u>Manage favorites now</u>	
	Perform required imports	File Edit View Insert Cell Kernel Help NotTrustee Python 3 (pykernel) O	
IN []:	Perform required imports.		
	import os Rectangular Snip	ine values for the voltage on the pulse voltage source and the values for the output of the dynamic ROM.	
	import matn import shutil import matplotlib.pyplot as plt	<pre>In [21]: e_value = "SOUL-outfield_mode_1" x = tb.post.get_solution_data(e_value, "Tar", "Time") plt.plot(x.intrinsics["Time"], x.data_real(e_value))</pre>	
	<pre>from pyaedt import TwinBuilder from pyaedt import generate_unique_project_name</pre>	pyedt info: Solution Data Correctly Loaded.	
	<pre>from pyaedt import generate_unique_folder_name from pyaedt import examples</pre>		

	Select version and set launch options	4000	
	Select the Twin Builder version and set launch options. The fo	4000 V V V V V	
	You can change the Boolean parameter non-graphical to	40000 V V V 40 65 10 15 20 25 30 1411	
In []:	Twin Builder in non-graphical mode. You can also change the new thread to False to launch Twin Builder in an existing	In [22]: e_value = "ROHL.outfield_mode_2"	
	if one is running.	<pre>>> co.pos.get_bolicitinger(reades, if, if if</pre>	
	<pre>desktop_version = "2023.1" non graphical = os.getenv("PYAEDT NON GRAPHICAL",</pre>	Out[22]: [<mstplotlib.lines.line20 0x1a1e9770610="" at="">]</mstplotlib.lines.line20>	
	new_thread = True		
	######################################		
		-200 -	
		-400 - V V V	
		00 05 10 15 20 25 30 le11	



Easy Debug and Error Log Access

What's New

- Twin Generation Log
- Advanced log for Simulation



- Magnify icon now shows a detailed log window
- Easy access to debug and logs for easier debugging







Compiler Upgrades for 2023 R1

What's New

- Compiler Upgrades for 2023 R1 (Visual C++ 2022)
- Modelica users can now use an external version of GCC for compilation of Modelica models



- Added Support for Visual C++ 2022
 - Modelica support stays at Visual C++ 2019 for now
 - Support for Visual C++ 2013 dropped
 - Installation of MFC libraries now optional and off by default
 - Available for C-model, VHDL and Python models





